At ST, we are creators and makers of semiconductor technologies. We work with our customers and partners to design and build products, solutions, and ecosystems that address their challenges and opportunities, and the need to support a more sustainable world.

WHAT WE DO
We create semiconductor solutions which are integrated into each of the billions of electronic devices people across the globe interact with every day. By getting more from technology to get more from life, ST stands for life.augmented.

WE ARE DRIVERS OF YOUR INNOVATION
We build products, solutions and ecosystems that enable smarter mobility, more efficient power and energy management, and the wide-scale deployment of the Internet of Things and connectivity technologies.

At ST, we are creators of technology. Our technology starts with You.

KEY FACTS
- Integrated device manufacturer with 14 main manufacturing sites
- President and CEO: Jean-Marc Chery
- Corporate Headquarters: Geneva (CH)
- Committed to sustainability: Signatory of the United Nations Global Compact (UNGC), Member of the Responsible Business Alliance (RBA)
- Committed to be carbon neutral by 2027

SALES & MARKETING
- $16.1 billion revenue in 2022
- 80 offices in 35 countries
- Over 200,000 customers worldwide

PEOPLE & INNOVATION
- More than 50,000 employees worldwide
- ~115 nationalities
- 9000+ people working in R&D and product design
- ~19,500 active and pending patents
Semiconductor solutions: one of the industry’s broadest product portfolios

We create innovative semiconductor solutions based on:

- Dedicated Automotive ICs
- Analog, Industrial & Power Conversion ICs
- Discrete & Power Transistors
- MEMS & Optical sensing solutions
- General Purpose MCUs & MPUs, Secure solutions
- ASICs based on ST proprietary technologies

Our products and solutions enable customer innovation

Trends that drive our innovation

**Smart mobility**

Thinking differently about how we move around, reducing pollution and congestion through car electrification and digitalization

**Power and energy**

More efficient power and energy management to address increasing global energy demand while reducing the environmental impact

**Internet of Things & Connectivity**

Transforming every area of our lives and the objects we use with billions of cloud-connected devices for personal, business, and public applications

Technology

We have a unique set of chip-manufacturing and packaging technologies enabling solutions for the markets we serve.

- MEMS for sensors & Micro-actuators
- Smart Power: BCD (Bipolar - CMOS - Power DMOS)
- FD-SOI CMOS
- FinFET through Foundry
- Analog & RF CMOS
- Vertical Intelligent Power
- eNVM CMOS
- Optical sensing solutions
- MEMS for sensors & Micro-actuators
- Smart Power: BCD (Bipolar - CMOS - Power DMOS)
- FD-SOI CMOS
- FinFET through Foundry
- Analog & RF CMOS
- Vertical Intelligent Power
- eNVM CMOS
- Optical sensing solutions

Packaging technologies

- Leadframe – Laminate – Sensor module – Wafer level

Manufacturing facilities

We believe in the benefits of owning manufacturing facilities and operating them in close proximity and coordination with its R&D operations.

Manufacturing facilities

- France (Crolles, Rousset, Tours)
- France (Rennes)
- Italy (Agrate, Catania)
- Italy (Marcianise)
- Sweden (Norrköping)
- Malta (Kirkop)
- Morocco (Bouskoura)
- Singapore
- Malaysia (Muar)
- China (Shenzhen)
- Philippines (Calamba)

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